

# Femtosecond laesr Micro-nanomachining system



株式会社 東京インスツルメンツ **TOKYO INSTRUMENTS, INC.** 

# Real high quality micro processing for Biological sample/

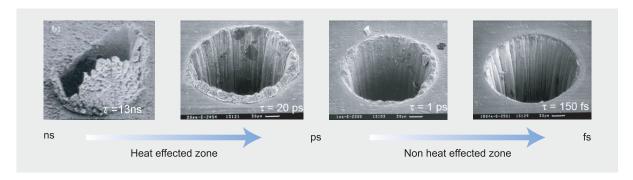
## **Transparent material / Thin film material**

#### >> Feature

#### **Cold processing**

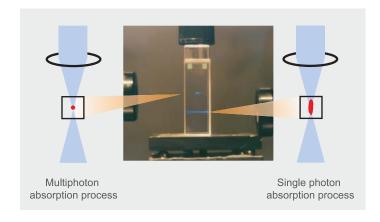
In case of femtosecond laser, it is possible to do processing at focus point without heat affect around the point because femtosecond laser irradiates sample during ultrashort time.

It is possible to get very high quality processing sample.



# High resolution over diffraction limit with multiphoton absorption

In case of transparent material, it is possible to do processing with beam spot size over diffraction limit(less than 300nm) inside sample



#### **Direct drawing**

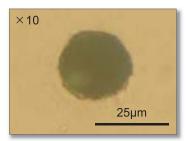
You can check microscope imaging and decide on processing condition on Monitor(Touch screen monitor).

#### High accuracy auto-focus mechanism with confocal optical system

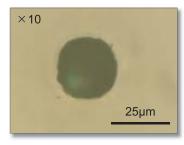
It is possible to find sample surface position for low reflection samples. As advanced function, it is possible to do processing including tilt and rotation offset of sample.

Other lasers(CW, ns and ps laser) instead of fs laser are available.

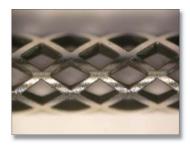
## Micromachining samples



Through hole of metal material (Front surface)



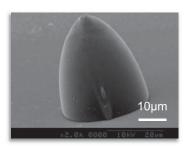
Through hole of metal material (Rear surface)



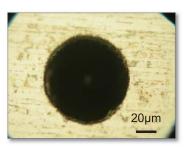
Stent cutting (Stainless)



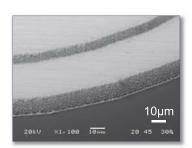
Inside processing of silicon wafer (Cut surface)



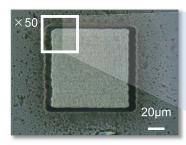
3D laser ligthography (Two-photon Photopolymer)



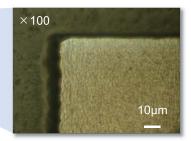
Through hole of metal material (SUS304)



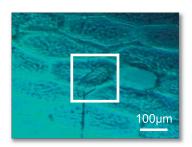
Cutting of metal material (Pt)



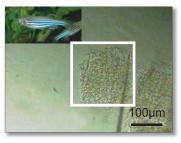
Ablation of DLC film



Ablation of DLC film



\* Isolation of single cell (Onion)



\* Sample cutting in water (Zebra fish)



\* Laser induced mutation of yeast sample (High added value yeast)

#### **Specification**

	Products	cts Solid state laser		Fiber laser
Laser	Wavelength*1	800nm/1028nm		1064nm
	vvavelengtn	800nm/1028nm		1064nm
	Pulse energy*2	<3.5mJ@1kHz/800nm		<2μJ@1MHz
		<0.2mJ@1kHz/1028nm		
	Repetition rate <sup>*3</sup>	Single shot∼1kHz@800nm Single shot∼200kHz@1028nm		Single shot∼1MHz
	Pulse duration*4	<100fs@800nm <290fs@1028nm		<500fs
	Spatial mode	TEM <sub>00</sub> M <sup>2</sup> <		<1.3
Optical unit <sup>*5</sup>	Auto-focus mechanism with confocal optical system: Scan range ±2mm, resolution<1µm Control of pulse energy and polarizaion			
Irradiation unit	Positioning stage *6: Stepping motor stage		XY axis:±50mm、resolution:2μm、Maximum scan speed:16mm/s Z axis:0~20mm、resolution:1μm、Maximum scan speed:5mm/s	
	Sample stage <sup>*7</sup>		Vacuum table(Stainless steel)	
	Microscope based body,Irradiation optical system,Observation optical system			
Control unit	Controller,Power supply,Software			
Optical table with air spring <sup>*8</sup> (Vibration removal optical table with air spring)	Optical table(Steel honeycomb structure):1500(W)×800(H)×1800(L)mm			
Physical characteristics*9	Main unit(including Laser, Optical unit, Irradiation unit and optical table): $1500(W) \times 1800(H) \times 1800(L)mm$ Control unit: $900(W) \times 1000(H) \times 570(L)mm$ (19 inch rack mount)			
Operating conditions	Main unit: AC100V/20A (Including Optical unit, Irradiation unit and Optical table) Laser: AC100V/60A@800nm、AC100V/20A@1028nm、AC100V/3A@1064nm			

- Harmonic module unit option
  - Wavelength800nm→Wavelength400nm/266nm
  - Wavelength1028nm→Wavelength515nm/343nm/257nm Wavelength1064nm→Wavelength532nm/355nm/266nm
- High energy option
- Up to 1.0mJ@1kHz
- \*3 High repetition rata option Up to 10kHz@800nm Up to 1MHz@1028nm
- \*4 Extend pulse duration option
  - Up to 10ps
- Beam shaping and Polarization conversion option
  - Top-hat beam,Multi-beam,etc
  - Circular, Radial and Azimuth polarization
- It is possible to select other stage. (linear motor, piezo motor stage, Galvo mirror, etc.)
- It is possible to select porous ceramic vacuum table.
- It is possible to select rubber spring type and stone surface type.
- It will change physical characteristics depend on configuration.
- \*If you have any requets, It is possible to customize system.

Please do not hesitate to contact us.

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